

Press Release

NOVA Integration Solutions is Entering into a Collaborative Supplier Agreement with WaveTherm Corporation

Saint Cloud, Florida, June 2013: NOVA Integration Solutions (NIS), known for their advanced electronic packaging, is entering into a collaborative supplier agreement with WaveTherm Corporation. The agreement establishes WaveTherm as a strategic supplier to NIS specific to the development of high-performance standard and custom heatframe assemblies installed into their enclosures.

The goal of the relationship is to provide our customers with engineering support and the early-stage design guidance required to meet today's demands for advanced thermal management starting at the board-level through the finished system-level solution provided by NIS. WaveTherm will provide the engineering and the highly-specialized board-level resources to NIS in a collaborative co-engineering manner in support of this objective. The relationship is expected to expand the advanced packaging capabilities offered by NIS as well as exposing WaveTherm to new opportunities.

About NOVA Integration Solutions: NOVA Integration Solutions Inc. (NIS), is an innovative engineering-based small business providing advanced electronic packaging to include the design, manufacture, integration and testing of sophisticated electronic equipment and embedded computers. The company is a leading provider of rugged and MIL SPEC enclosures currently used by the defense industry worldwide. NIS is known in the market for their custom airborne (ATR), ground mobile (LRU) and maritime rackmount enclosures. Rugged printers and custom backplanes are also provided to include a vast array of the high-performance, platform-specific hardware solutions.

For further information, inquiries should be directed to: NOVA Integration Solutions, **Michael Martyniak, VP of Marketing, 19 East 17th Street, Saint Cloud, FL 34769, mmartyniak@novaintegration.com, (407) 556-3934, www.novaintegration.com.**



About WaveTherm: WaveTherm is a unique provider of highly complex thermo-mechanical, standards-based, board-level products utilized in conjunction with Printed Circuit Boards (PCBs) to include an extensive range of engineering and manufacturing services. These heatframe and SolidWedge™ products are well suited for use with VPX, cPCI and custom rugged, convection and conduction cooled embedded modules.

WaveTherm's proven PCB Reference Designs and their line of OpenCOTS™ solutions provide thermal and mechanical considerations that can be utilized by hardware design teams in an effort to standardize nearly all of their packaging requirements with minimal customization of their assemblies.

OpenCOTS™ is a modular family of mechanical and thermal COTS products ideally suited for VPX and cPCI applications. They reduce product development time to include unnecessary fabrication costs associated with complex PCB designs. Custom applications are simplified through the use of WaveTherm's Part Number Builder to include an on-line reference design process resulting in fabricated parts in less than 4-weeks.

For further information, inquiries should be directed to: WaveTherm Corporation, **Josh Jenkins, Vice President, 182 Kitty Hawk Drive, Morrisville, NC 27560, jjenkins@wavetherm.com, (919) 210-3280, <http://shop.wavetherm.com/>.**

